BEOCIATION CONNECTING LECTRONICS INDUSTRIES® AND ADDRESS AND ADDRE				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
	2-21.1 IPC Web Site for Information on IPC-1752 Standard Form Distribution http://www.ipc.org/IPC-175x Distribution				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					lfg Informat	ion		
Supplier Information													
Company name*	Company un	Company unique ID			Unique ID Authority				Response Date*				
onsemi										2023-06-08			
Contact Name Title - Con			Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - R			tle - Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item		Number Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type
	NCP810	NCP81038MNTWG Synchronous Buc		k Controller		2023-06-08 PH1		H1	45.2		mg	Each	
Manufacturing Proccess Infor	mation												
Terminal Plating / Grid Array Material Terminal Base Allo		Alloy J	J-STD-020 MSL	Rating	Peak Proc	ess Body Te	mperature	e Max Time at Peak	Tempera	ture Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy			1	1		260		С	30	secor	nds 3		
Comments													
level 1 - maximum time at peak tempe	rature during so	ldering is 10-3	0 seconds										
For more information regarding mate	rial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	nogeneous Material Weight Unit of Mea		Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	2.98	mg	Supplier	Silicon (Si)	7440-21-3		2.98	mg	
Die Attach	0.55	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.11	mg	
			Supplier	Silver (Ag)	7440-22-4		0.44	mg	
Lead Frame	16.95	mg	Supplier	Silver (Ag)	7440-22-4		0.339	mg	
			Supplier	Iron (Fe)	7439-89-6		0.3729	mg	
			Supplier	Copper (Cu)	7440-50-8		16.2381	mg	
Mold Compound-Black	22.5	mg		Epoxy Phenol Resin	proprietary data		2.025	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		20.475	mg	
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg	
Wire Bond - Cu	0.33	mg	Supplier	Copper (Cu)	7440-50-8		0.33	mg	